



## IEEE India Council Newsletter

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### Message from the Chairman



Dear IEEE Indian Members,

First of all, I would like to thank all the IEEE India members for showing the trust on me to serve as IEEE India Council (IC) Chair for 2019. It is a great honour with big responsibility for me. I will try my best to meet the expectations of IEEE members in India. I am extremely happy to have a very strong and energetic team including office bearers and ExeCom members to take forward to various activities of IEEE IC. My appreciation and heartfelt thanks to all of them for shouldering such responsibility. As we all know that IEEE India Council (IC) works in total synchronism and harmony of actions and thoughts of its members. I am fully confident that we will work even better manner during 2019.

As you may be aware that Mr. H.R. Mohan has once again taken up the challenging task of the Newsletter Editor (He was the editor during 2013 & 2017-2018). I thank the Section leaders for their support & cooperation in providing the inputs to the newsletter. The flagship program of IEEE IC, viz. INDICON 2019, will be held in Marwadi University, Rajkot in collaboration with IEEE Gujarat Section in Dec 2019. I hereby appeal to all members to make this INDICON another success story, as in the previous years. All India Student, Young Professional, Women in Engineering Congress (AISYWC) 2019 will be hosted by Hyderabad Section. Vice-Chairs, Student Activities (Dr Rajashree Jain), YP (Er Vamshikrishna J) and WIE (Dr Rachana Garg) are working in consultation with Hyderabad Section Chair. The details will be communicated soon.

IEEE Kerala Section is hosting TENCON-2019, the prestigious conference of IEEE R10 at Kochi during 17-20 Oct 2019 on the theme “Sustainable and Innovative Technologies For A Brighter Tomorrow”. IEEE Kolkata Section will be hosting TENSYP-2019, another flagship conference of IEEE R10 at Kolkata during June 7-9, 2019 on the theme “Technological Innovation for Humanity”. Both these events will be great opportunities for our members to submit papers, network, enhance their domain expertise and expand their knowledge base.

Being the IC Chair Elect during 2017-2018, I found that IC has moved rightly far ahead with leaving back the differences. There are few concerns about the INDICON, AISYWC which need to be stream-lined. New Technically Co-Sponsored conference fee imposed by IEEE should be implemented without hampering the number of events. In the second IC ExCom meeting held in Melbourne on March 3, 2019, it was decided to close the IC chapter due to various complaints and sustainability, and merge them to the sections. New guidelines for IC Awards and eNotice are formulated and few more issues need to be looked into are

- Reach and regular broadcast of IC Newsletter to be increased.
- More information on IC Website can be posted for benefit of the members.
- Organisation of Leadership programs for women, conference organisers, students, YP can be made.
- Membership retention, growth and their elevation to higher grade should be increased.
- Creation of Joint Secretary, advisors and inclusion of sub-sections chairs in IC ExCom can be explored.

I am sure that with the help of active IEEE volunteers in India, we will be able to make one of the best councils of IEEE. Please do look for regular newsletters and other updates.

With warm fraternal greetings

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